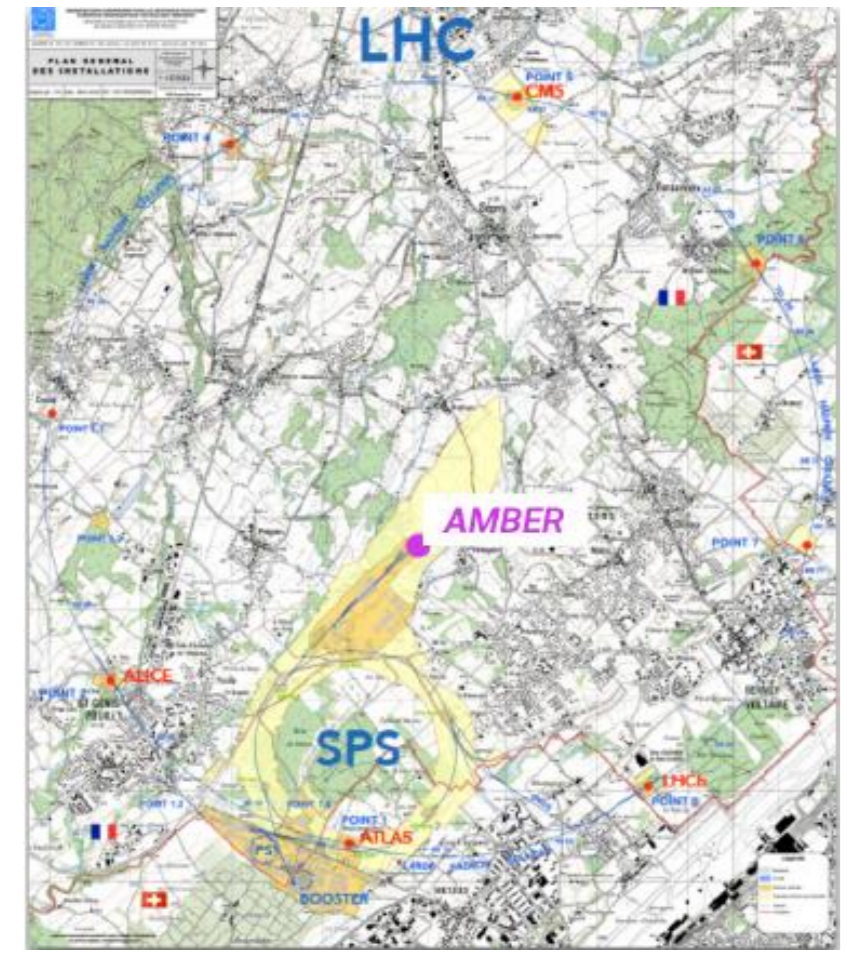


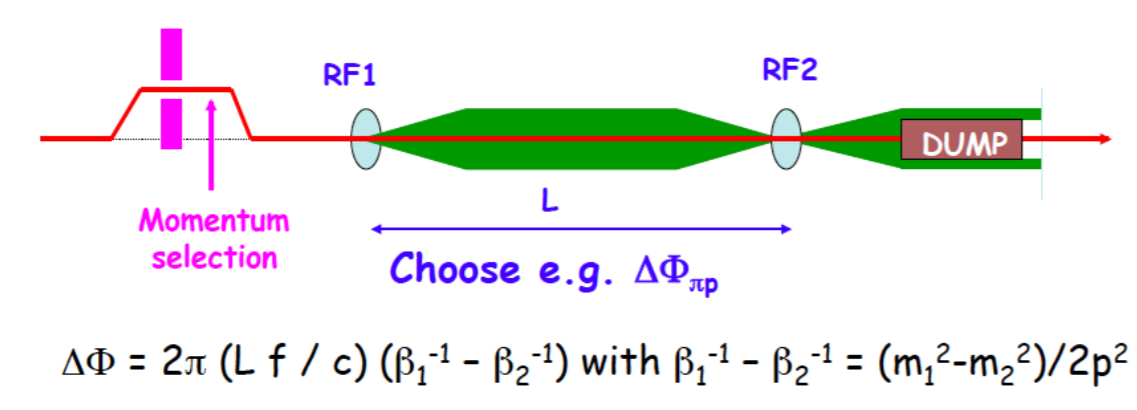
# Development and test of the Micromegas detector prototype and its readout electronics for the AMBER experiment at CERN

C. Alice on behalf of the working group

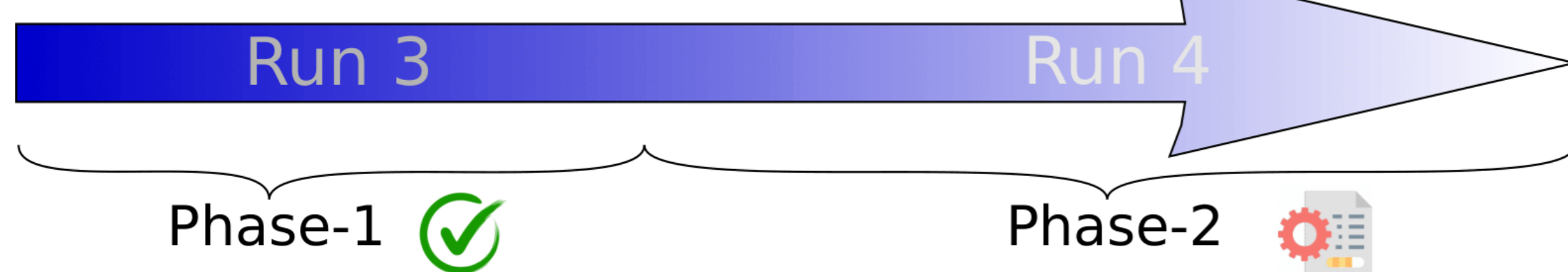
## The AMBER experiment at CERN



**AMBER Collaboration:**  
13 countries + JINR (Dubna),  
33 institutions, ~ 200 members.



Conventional muon/hadron M2 beams

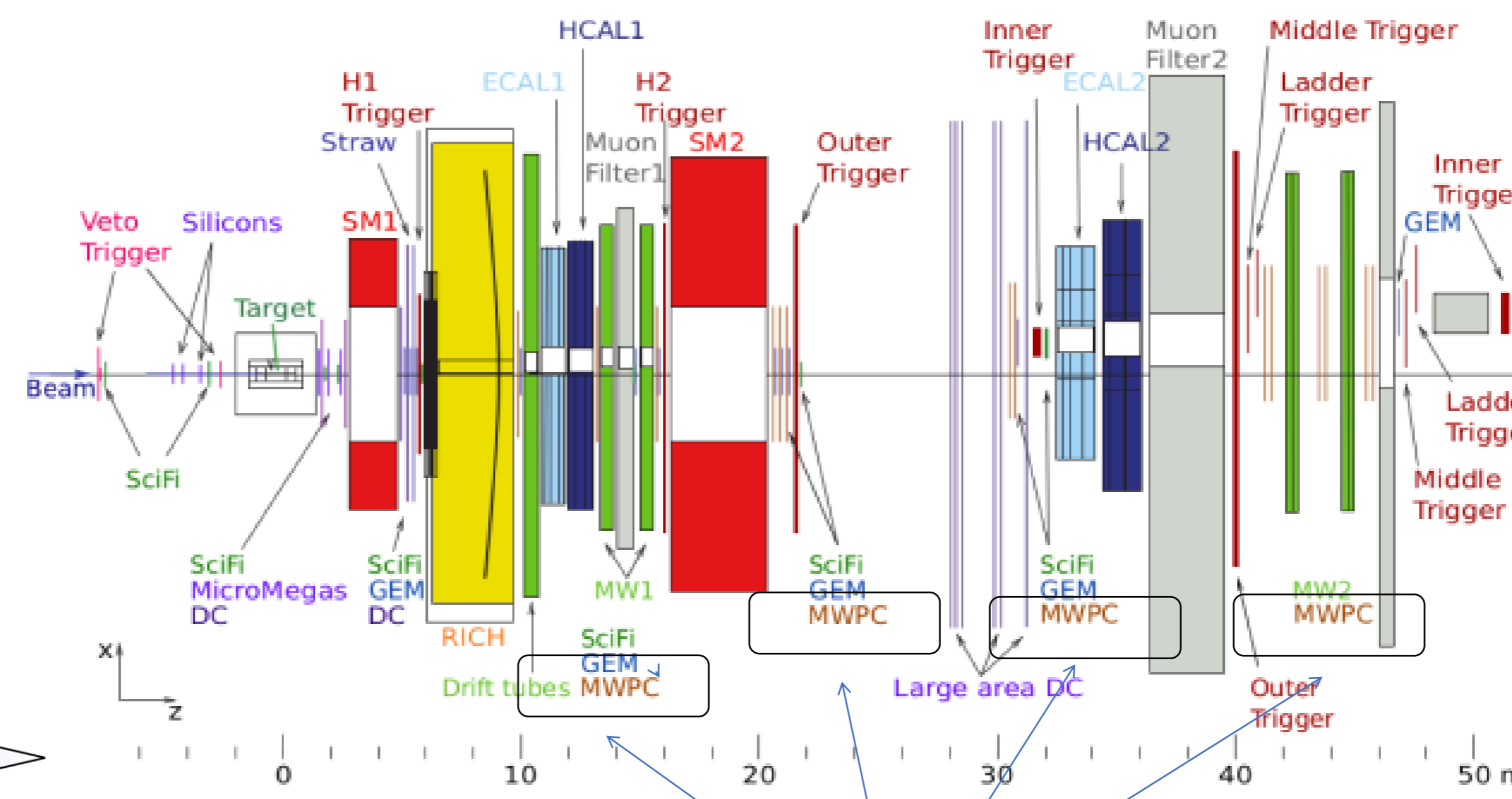


Proton Radius Measurement  
Antimatter production cross section  
Pion and kaon structure (PDFs and PDAs)  
via DY and J/Psi production

Phase-1: Proposal approved by RB on 02/12/2020

Phase-2 Proposal submission in the middle of 2023

## 2025 Drell-Yan setup



Candidates to be substituted

An MPGD detector with the new triggerless RO could find its first application during the Drell-Yan Pilot Run which is currently scheduled to the end of 2025.

## MM development

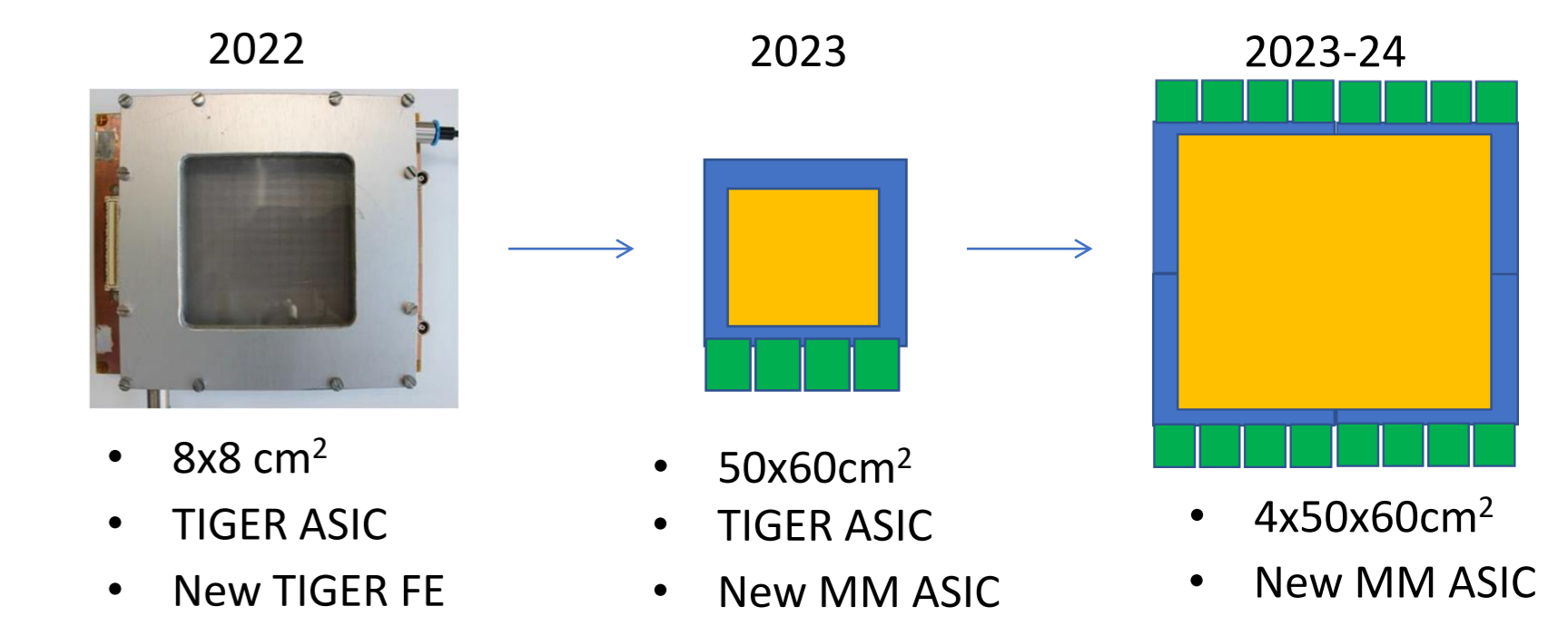
Detectors requirements:

- Active area – up to 180x150 mm<sup>2</sup>
- Rates – ~150kHz/mm<sup>2</sup> (centre), 1-2 kHz/mm<sup>2</sup> (periphery)
- Thickness – 0.3-0.5 %/plane
- Possibly, proven design

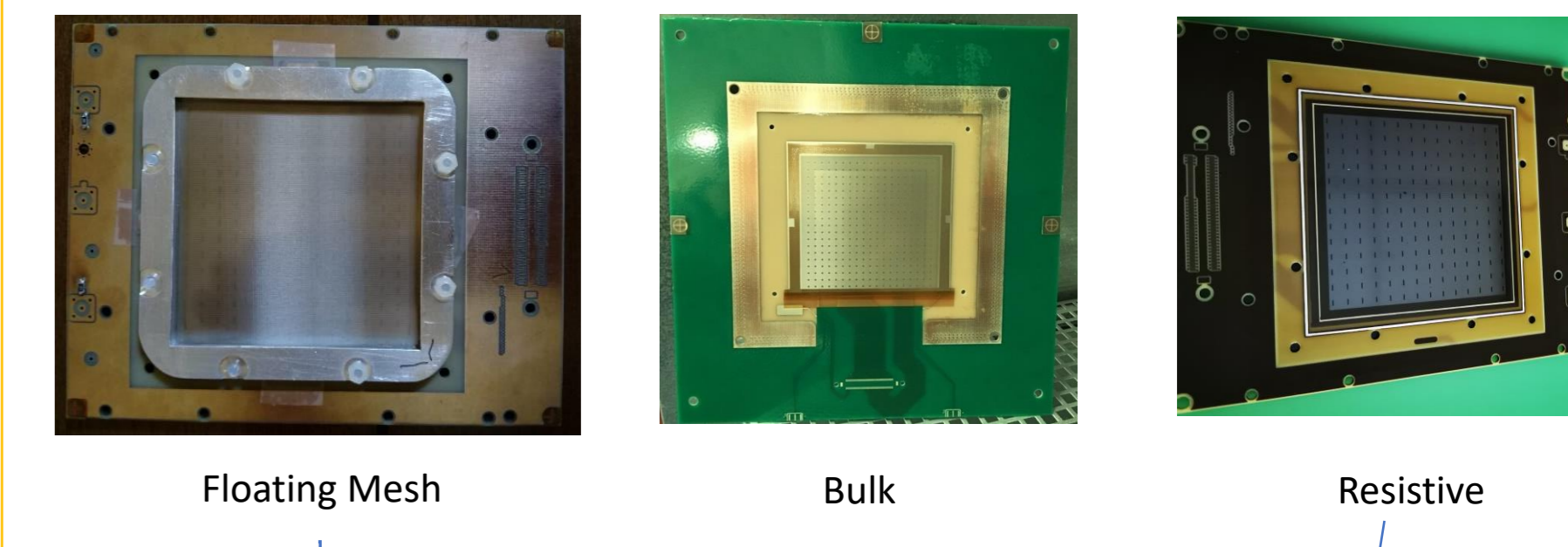
To achieve that we would like to rely on a proven technology, a group with expertise and possibly a production site

Micromegas JINR group involved in the ATLAS NSM project with a production site

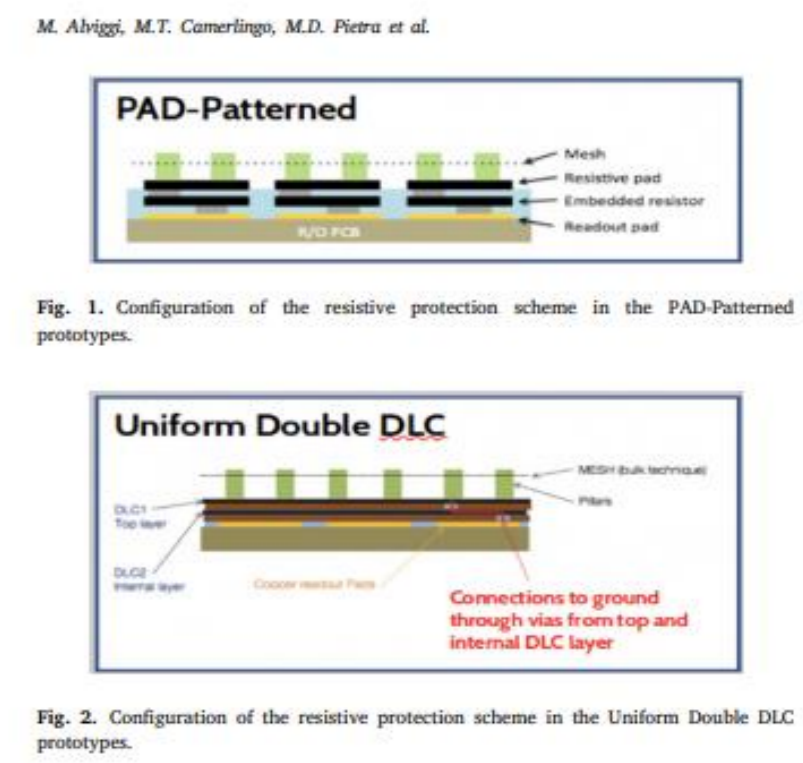
Prototyping timeline:



Building technologies:

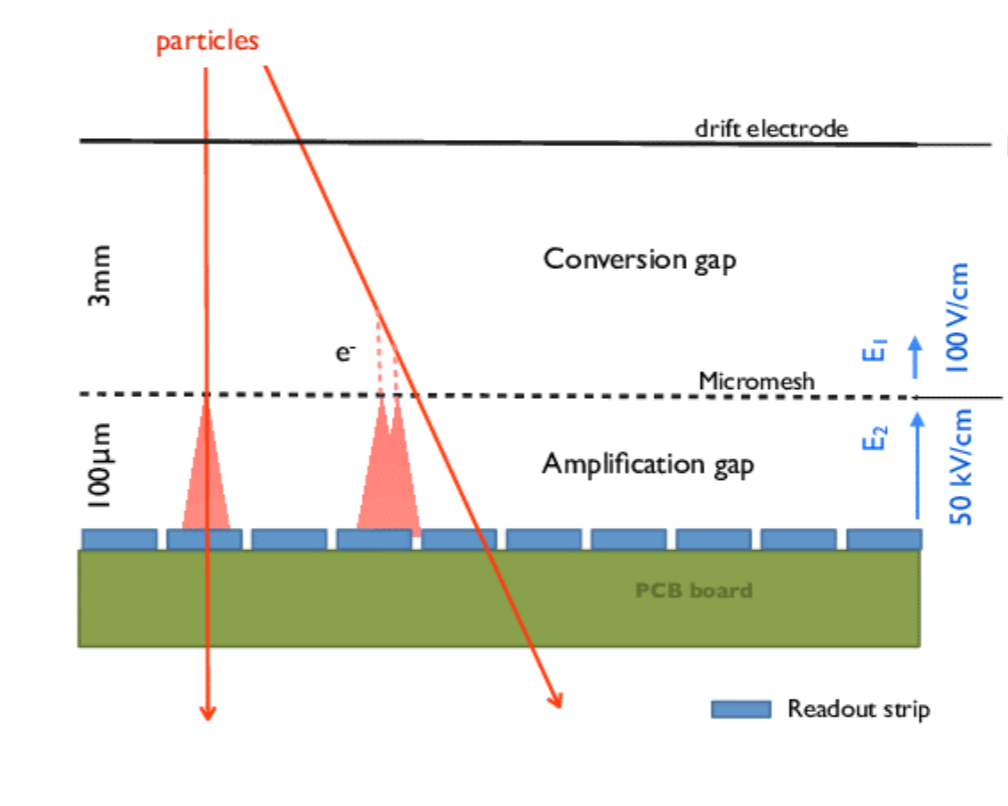
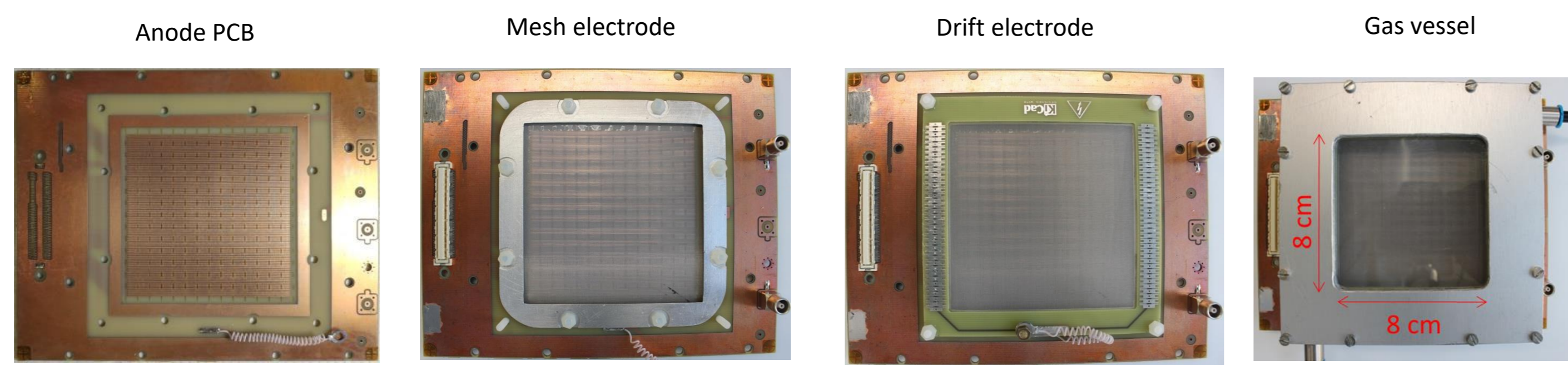


Possible collaboration for a Pixelated Resistive MM detector with the ATLAS INFN-Roma3 group

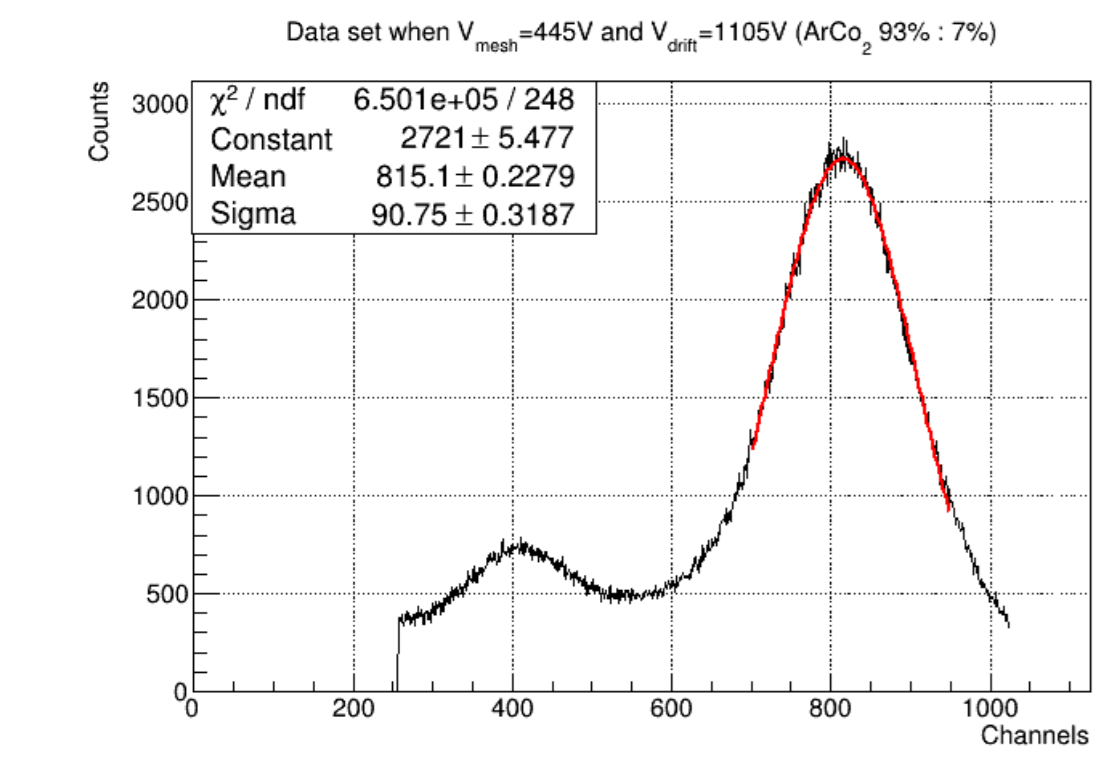


## Our prototype: non-resistive floating mesh MM

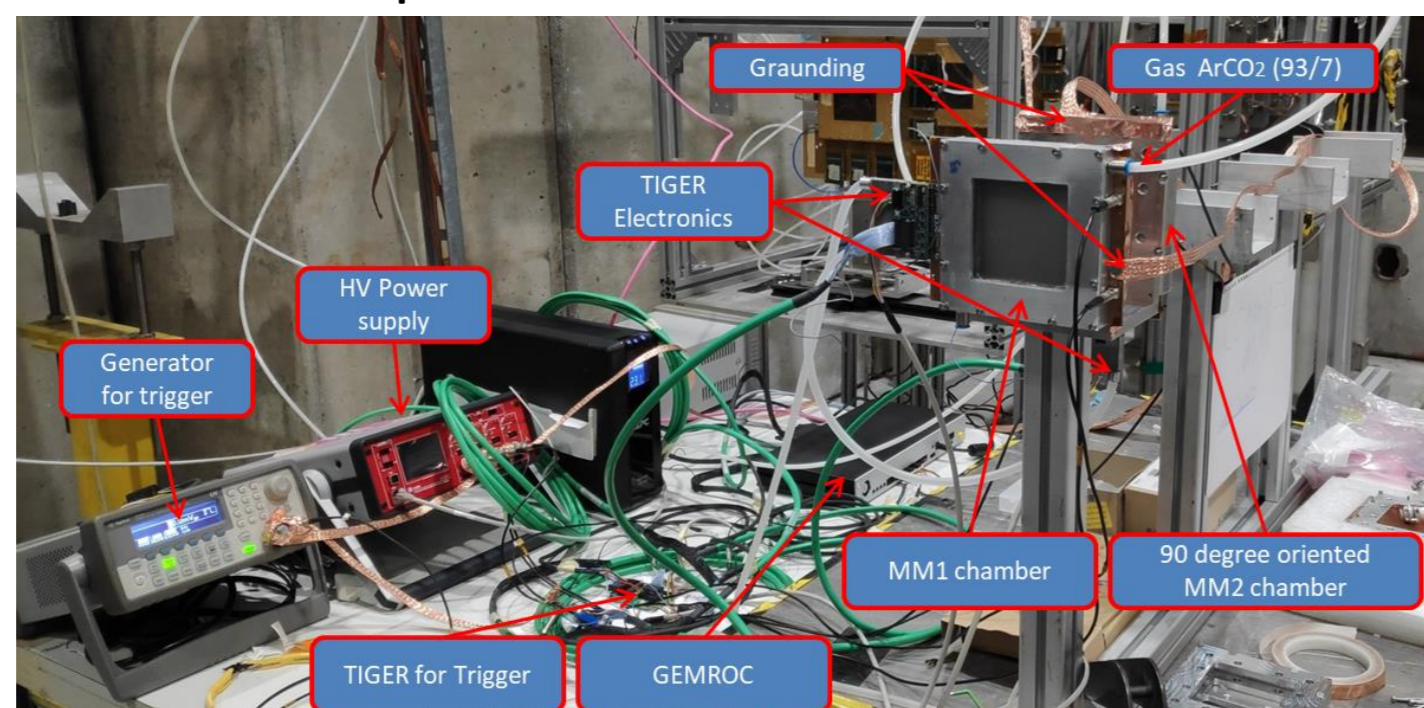
- Active area: 6,8 x 6,8 cm<sup>2</sup>
- Amplification gap: 128 μm
- Conversion gap: ~ 5 mm
- Strips width: 400 μm
- Pitch: 550 μm
- Holes: 45 x 45 μm<sup>2</sup>
- Wires diameter: 18 μm



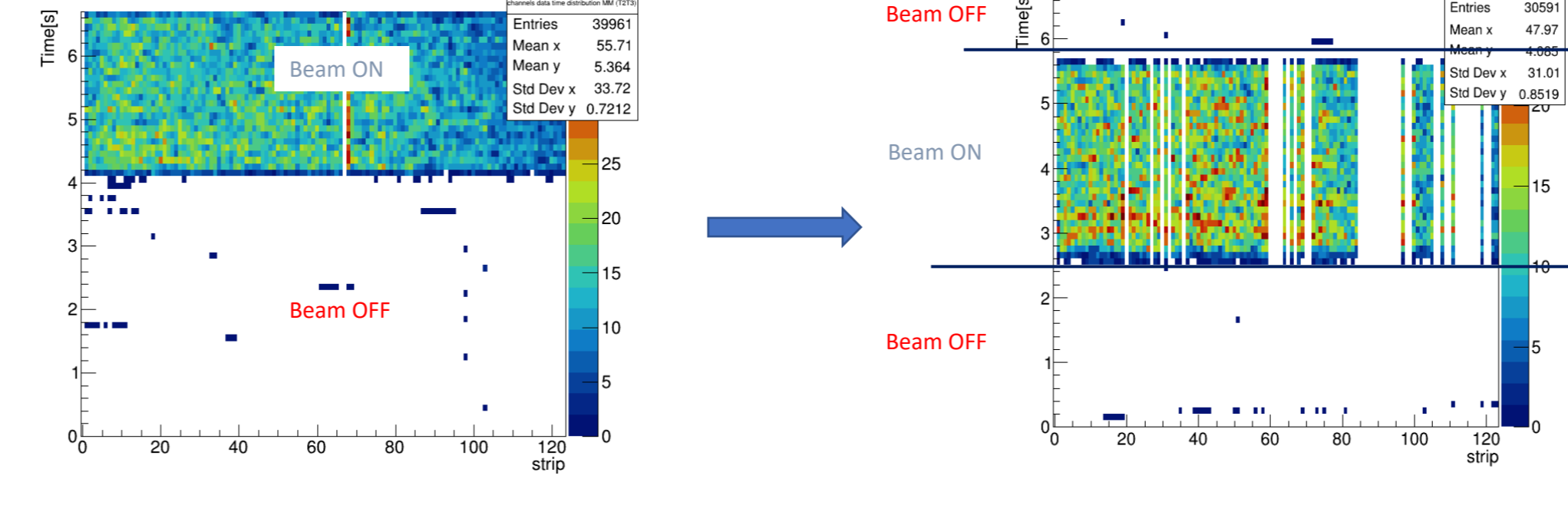
## Fe55 laboratory test with MCA



## Operation at the RD51 TB



## channel data time distribution MM (T2 T3)



## Quality check of the production

An optical system to analyse the anode defects has been implemented

Strips voltage 520V

MM detector

Video frames merged to obtain the discharges distribution

We can address the problematic areas

Kapton tape added

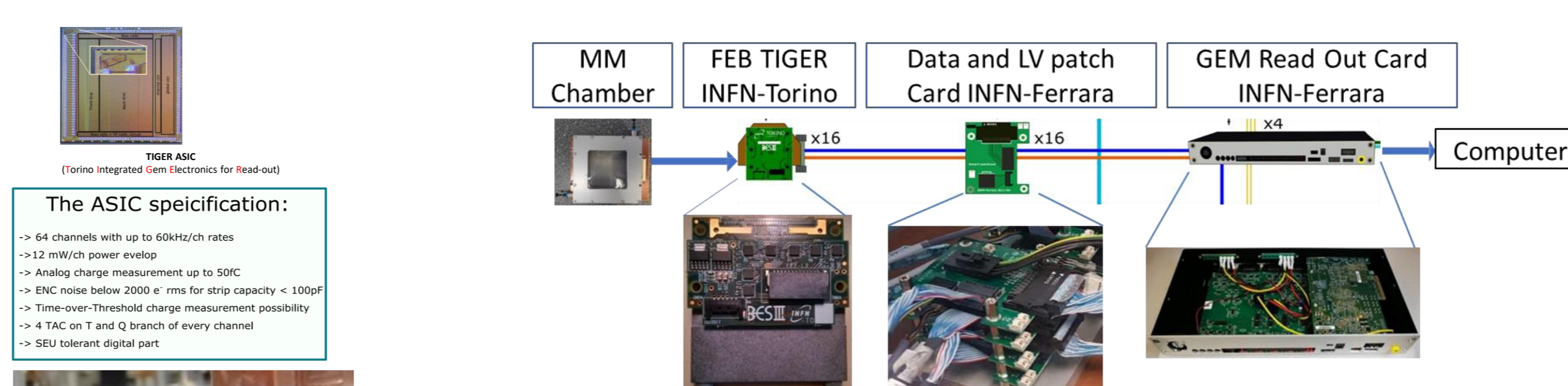
Only local defects of the Cu on the strips

We have removed the problematic areas

Strips voltage 590V

The GND is provided by soldering of a trace, not through the connector

## Initial digital RO chain



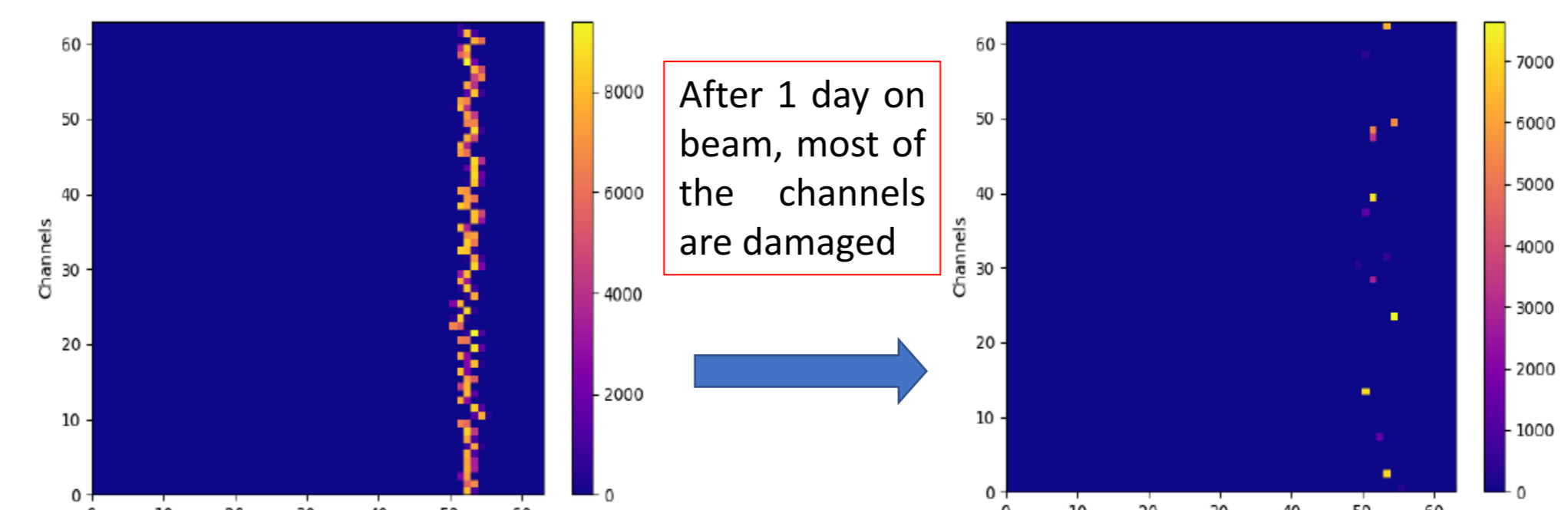
OFF-DETECTOR electronics: GEMROC based RO (Fe&To INFN)

ON-DETECTOR electronics: TIGER ASIC based FE card

DAQ software: GUF1 DAQ software (To INFN)

Two issues were identified

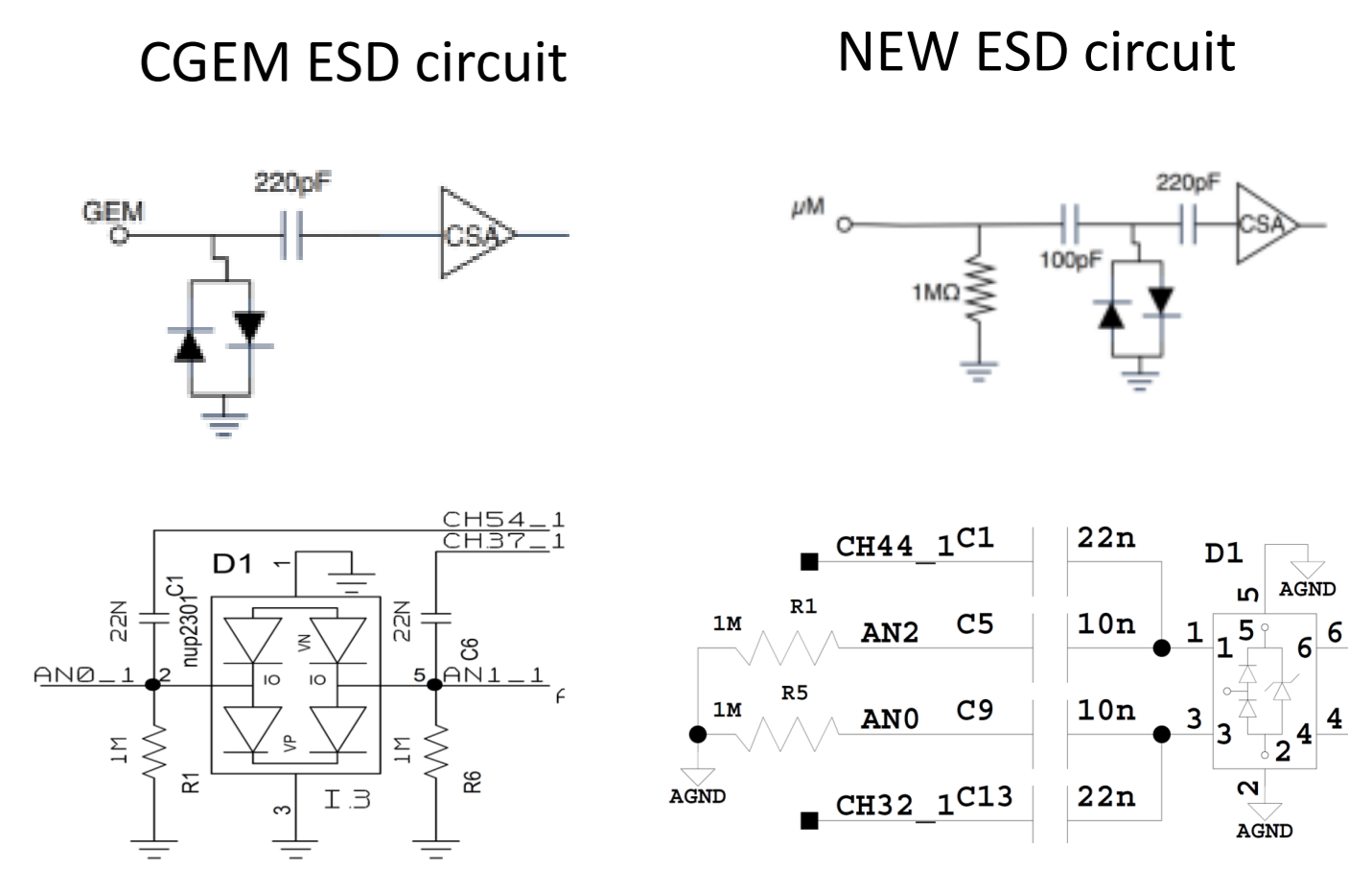
- The grounding could be tricky
- The discharge protection circuit is not sufficient in our configuration



## FE challenges

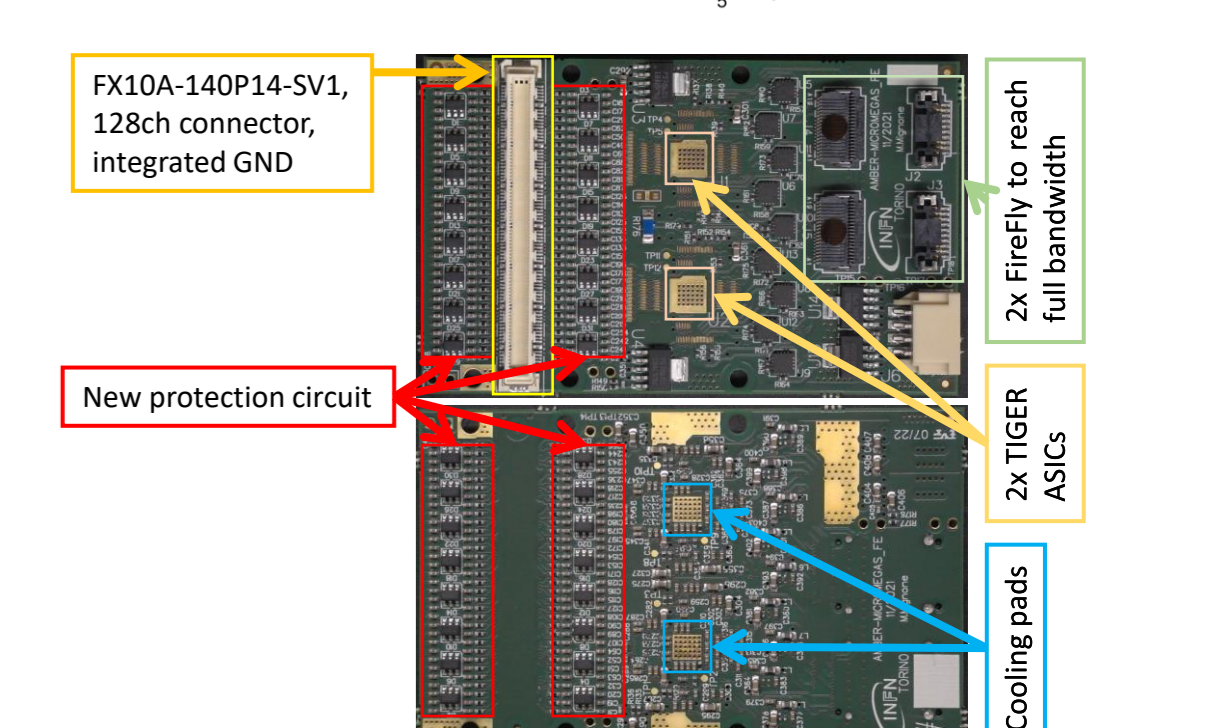
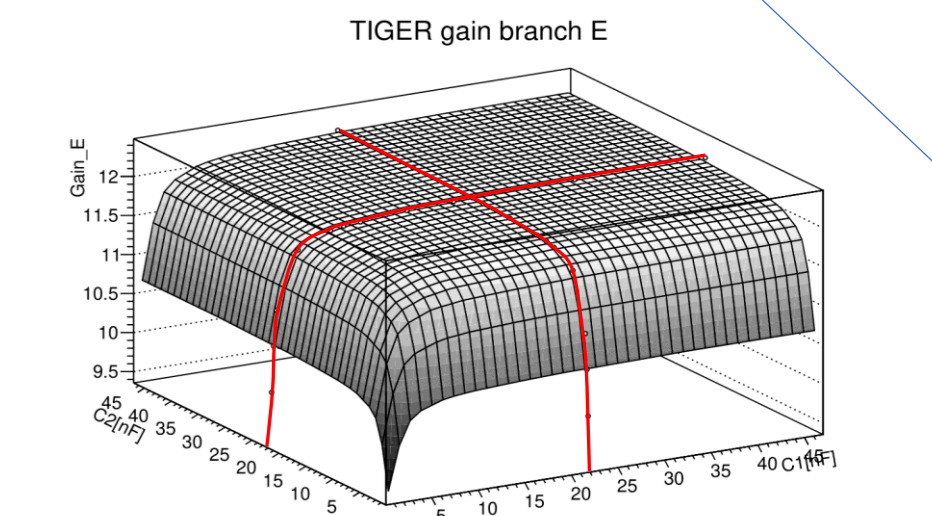
A new specific dedicated ASIC for MPGD detector is under development by INFN-Torino

New ESD protection circuit have been designed in order to face up the MM detector discharges

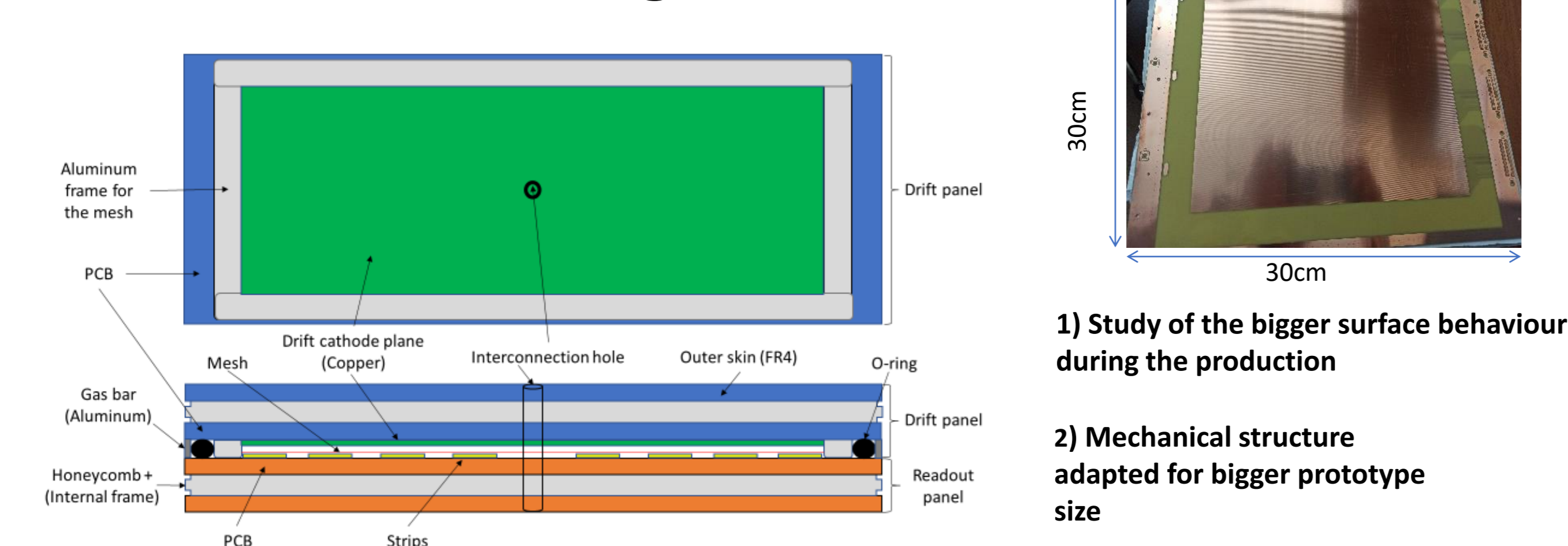


The new protection circuit will allow for an individual channel quenching.

Simulations with different capacitor values



## Mechanical challenges



## Software challenges

The online monitoring software still under development.

